## DECLARATION FOR PATENT APPLICATION

Docket Number (Optional)

MR1957-777

As a below named inventor, I	l hereby ded	clare that:

My residence, post office address	s and citizenship are as stated below r	ext to my name.	
names are listed below) of the su ADAPTER STRUCT	bject matter which is claimed and for to the control of the contro	ted below) or an original, first and joint inventor (if plural which a patent is sought on the invention entitled , the specification of	
which is attached hereto unless t			
		plication Number or PCT International Application	
Number	and was amended on	(if applicable).	
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56.  I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.  Priority Not Claimed			
(Number)	(Country)	(Day/Month/Year Filed)	
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(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.			
(Application Number)	(Filing Date)	<del> </del>	
I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.			
(Application Number)	(Filing Date)	•	
(Application Number)  I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Morton J. Rosenberg, #26,049; David I. Klein, #33,253; Jun Y. Lee, #40,262; David R. Wood, #53,868; Harry L. Sernaker, #50,595  Address all telephone calls to 410-465-6678  Address all correspondence to Rosenberg, Klein & Lee 3458 Ellicott Center Drive-Suite 101  Ellicott City, MD 21043			
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of sole or first inventor (given name, family name) LIAO SHENG-HSIN (FAMILY NAME: LIAO)  Inventor's signature			
Additional Inventors are being named on separately numbered sheets attached hereto.			